	le standard											
	Operating Temperature Range		-55 to +105°C (Note1) Stora			ge Temperature Range			-10 °C to +60°C (Note3)		3)	
Rating	Operating Humidity Range Applicable Connector		20% to 80% (Note2	Note2) Storage Hum		Humid	ity Range)	40% to 70% (I	Note3	3)	
3			DF51%-20DS-2C(#	,	Current	nt			AWG 24 : 2.0A AWG 26 : 1.5A			
	Applicable Contact		DF11-EP2428PC(A)/PC	CF(A)					AWG 28 : 1.0			
					UL · C-UL Rating		Voltage		30 V AC/DC			
	Voltage		250 V AC/DC	0		Current		AWG 24 to 28 : 1.0A				
			Specifi	icatio	ons							
	Item		Test method				R	equire	ements	QT	A٦	
Construc										V		
	xamination		measuring instrument.		A	Accordin	ng to drav	ving.		X	X	
Marking	Characteris	Confirmed visu	ally.							Λ	~	
Electric Characteristics		<u></u>	<u>δ</u> 500 V DC. 1000 MΩ MIN.							Х	- 1	
Voltage Proof			650 V AC for 1 min.			No flashover or breakdown.				Х	_	
	cal Charact					to naon		round				
	al Operation		on and extraction.		N	lo dam	age, crac	k or lo	coseness of parts. 3	Х	-	
(Sn Plating		50.1									<u> </u>	
Mechanical Operation (Au Plating)		50 times inserti	50 times insertion and extraction.				X –					
Mating and unmating		It takes out and	It takes out and inserts with a conformity connector.				1.Insertion Force : 88.2N MAX. X –					
Force							tion Forc	e: 5	5.2N MIN.		1	
(Sn Plating)		It takes out and	It takes out and incorts with a conformity connector			Inserti	on Force		58.5N MAX.	Х	+	
Mating and unmating Force			It takes out and inserts with a conformity connector.						5.0N MIN.	Λ		
(Au Plating)												
Vibration			Frequency 10 to 55 Hz, single amplitude 0.75 mm, at			No damage, crack or looseness of parts. A -						
			10 cycles for 3 direction.				4					
Shock			Acceleration 490 m/s ² duration of pulse 11 ms at 3							Х	1 -	
Contact extraction force			times for 3 directions. Pull out the cable after housing fixation.			11.8N MIN				Х	+_	
	nental Char				1	I.OIN IV	111N				1	
Damp Hea			\pm 2°C , humidity 90 to 95	5 %, 96	h. 1	.Insula	tion resist	tance	: 500 MΩ MIN. 🖄	Х	<u> </u>	
(Steady State)			(After leaving the room temperature for 1 to 2h.)			2.No da	mage, cra	ack or	looseness of parts.		1	
Rapid Change Of			Temperature -55°C→ +105°C						: 1000 MΩ MIN. 🖄	Х	1 –	
Temperatu	ıre	Time Under 5 Cycles	30min→ 30min		2	No da	mage, cra	ack oi	looseness of parts.		1	
			ng time of the tank is 2 to	3 MIN)							1	
Devillent			(After leaving the room temperature for 1 to 2h.)								1	
Dry Heat		Exposed at	Exposed at $105\pm2^{\circ}$ C, 96h									
,										X	_	
Cold Remarks		Exposed at	-55±3°C, 96h							X X		
Cold Remarks Note 1:Inc Note 2:No Note 3:App	condensing oly to the cond	Exposed at erature rising by curre	-55±3°C, 96h				torage du	iring t	ransportation.			
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	Condensing oly to the cond or mounted on	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED	torage du	iring t	CHECKED	X		
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	condensing oly to the cond or mounted on	Exposed at erature rising by curre lition of long term sto pcb, operating tempe	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		lied for int	NED AKI			CHECKED SZ. ONO	X D 201	.9011	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	condensing oly to the cond or mounted on	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED AKI	APPROV	ED	CHECKED SZ. ONO HS. OKAWA	X D 201 201	.9011 .6060	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	condensing oly to the cond or mounted on	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED AKI		ED	CHECKED SZ. ONO	X D 201 201	.901 .6060	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	Condensing oly to the conder mounted on OUNT 6	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O DIS-H-000	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED AKI	APPROV	ED	CHECKED SZ. ONO HS. OKAWA	X D 201 201	.901 .6060 .6060	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	Condensing oly to the conder mounted on OUNT 6	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED AKI	APPROV CHECKE	ED ED ED	CHECKED SZ. ONO HS. OKAWA YN. TAKASHITA	X D 201 201 201 201	.901 .6060 .6060	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	Condensing only to the conder mounted on OUNT 6	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O DIS-H-000	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS		DESIGN	NED AKI	APPROV CHECKE DESIGNI DRAWI	ED ED ED	CHECKED SZ. ONO HS. OKAWA YN. TAKASHITA TT. OHSAKO	X D 201 201 201 201 201 201	.901 .6060 .6060 .6060	
Cold Remarks Note 1:Inc Note 2:No Note 3:App Afte	Condensing oly to the cond or mounted on OUNT 6 erwise specific Qualification	Exposed at erature rising by curre lition of long term sto pcb, operating tempe DESCRIPTION O DIS-H-000	-55±3°C, 96h ent. rage for unused products l erature and humidity range F REVISIONS 004571 2. 2. Test X:Applicable Test	e is appl	DESIGN TS. MIYA		APPROV CHECKE DESIGNI DRAWI	ED ED ED N	CHECKED SZ. ONO HS. OKAWA YN. TAKASHITA TT. OHSAKO TT. OHSAKO	X D 201 201 201 201 201 201	ATE 90111 6060 6060 6060 6060 0	